

# **Product Change Notification**

Change Notification #: 116838 - 00

Change Title: Intel® SSD D5-P4320 Series,

PCN 116838-00, Product Design, Firmware

**Update** 

Date of Publication: March 22, 2019

#### **Key Characteristics of the Change:**

Product Design

#### **Forecasted Key Milestones:**

| Date Customer Must be Ready to Receive Post-Conversion Material: | April 02, 2019 |  |
|--|----------------|--|
|--|----------------|--|

#### **Description of Change to the Customer:**

The Intel® SSD D5-P4320 Series SKUs listed in the Products Affected table below will have the firmware version updated from 3DV10110 to 3DV10111. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

## **Customer Impact of Change and Recommended Action:**

Intel will be shipping only post-conversion material starting the date identified above. Customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## **Products Affected / Intel Ordering Codes:**

| Marketing Name         | Product Code    | MM#    | Pre TA#    | Pre SA#    | Post TA#   | Post SA#   |
|------------------------|-----------------|--------|------------|------------|------------|------------|
| Intel® SSD D5-P4320    | SSDPE2NV076T801 | 979157 | K17571-003 | K17579-001 | K17571-004 | K17579-002 |
| Series (7.6TB, 2.5in   |                 |        |            |            |            |            |
| PCIe 3.1 x4, 3D2, QLC) |                 |        |            |            |            |            |
| Generic Single Pack    |                 |        |            |            |            |            |
| Intel® SSD D5-P4320    | SSDPE2NV076T810 | 979158 | K17573-002 | K17579-001 | K17573-003 | K17579-002 |
| Series (7.6TB, 2.5in   |                 |        |            |            |            |            |
| PCIe 3.1 x4, 3D2,      |                 |        |            |            |            |            |
| QLC) Generic 10 Pack   |                 |        |            |            |            |            |

## **PCN Revision History:**

Date of Revision: Revision Number: Reason:

March 22, 2019 00 Originally Published PCN

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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